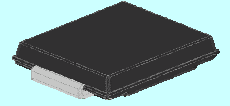




## MATERIAL COMPOSITION DECLARATION

**Supplier: Fagor Electrónica S. Coop**

**Package: SMC**



**Part Number:**

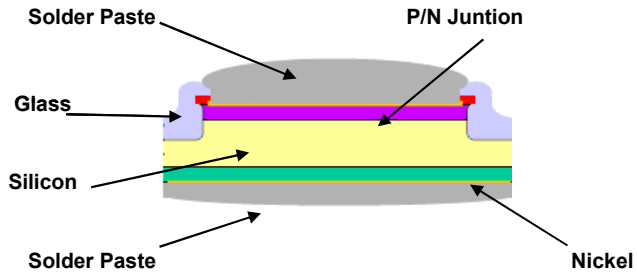
**Description:** General Purpose, Fast, Ultrafast, Zener and TVS diodes

COMPOSITION PART	MATERIAL NAME	MATERIAL MASS( mg)	MATERIAL MASS( %)	ELEMENT NAME COMPOSITION	CAS N°	ELEMENT % ( BY WEIGHT)	Cd (ppm)	Pb (ppm)	Hg (ppm)	Cr 6+ (ppm)	PBBs (ppm)	PBDEs (ppm)
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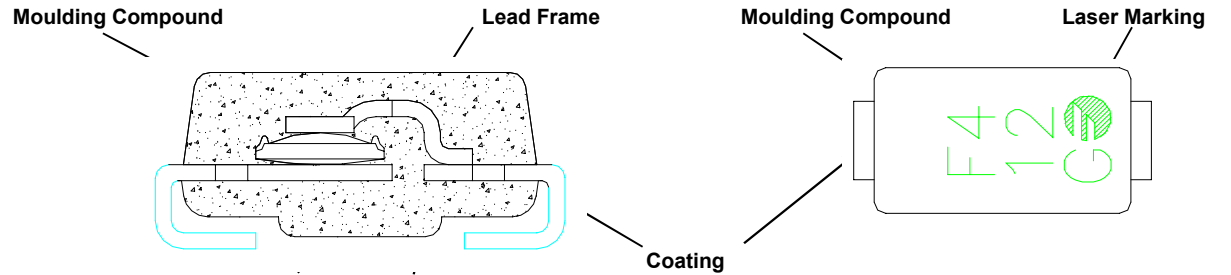
**Exception according to annex of Directive 2002/95/EC (RoHS):**

\* Lead in high melting temperature type solders (i.e. tin-lead solder alloys containing more than 85% lead)

\*\* Lead in glass of cathode ray tubes, electronic componentes and fluorescent tubes



**CHIP DRAWING**



**Lead Frame**

**DIODE DRAWING**